IS61LV3216L

32K x 16 LOW VOLTAGE CMOS STATIC RAM

FEATURES

- High-speed access time: 10, 12, 15, and 20 ns
- CMOS low power operation
  - — 130 mW (typical) operating
  - — 150 μW (typical) standby
- TTL compatible interface levels
- Single 3.3V + 10%, –5% power supply for 10 and 12 ns
- Single 3.3V ± 10% power supply for 15 and 20 ns
- Fully static operation: no clock or refresh required
- Three state outputs
- Industrial temperature available
- Available in 44-pin 400mil SOJ package and 44-pin TSOP-2

DESCRIPTION

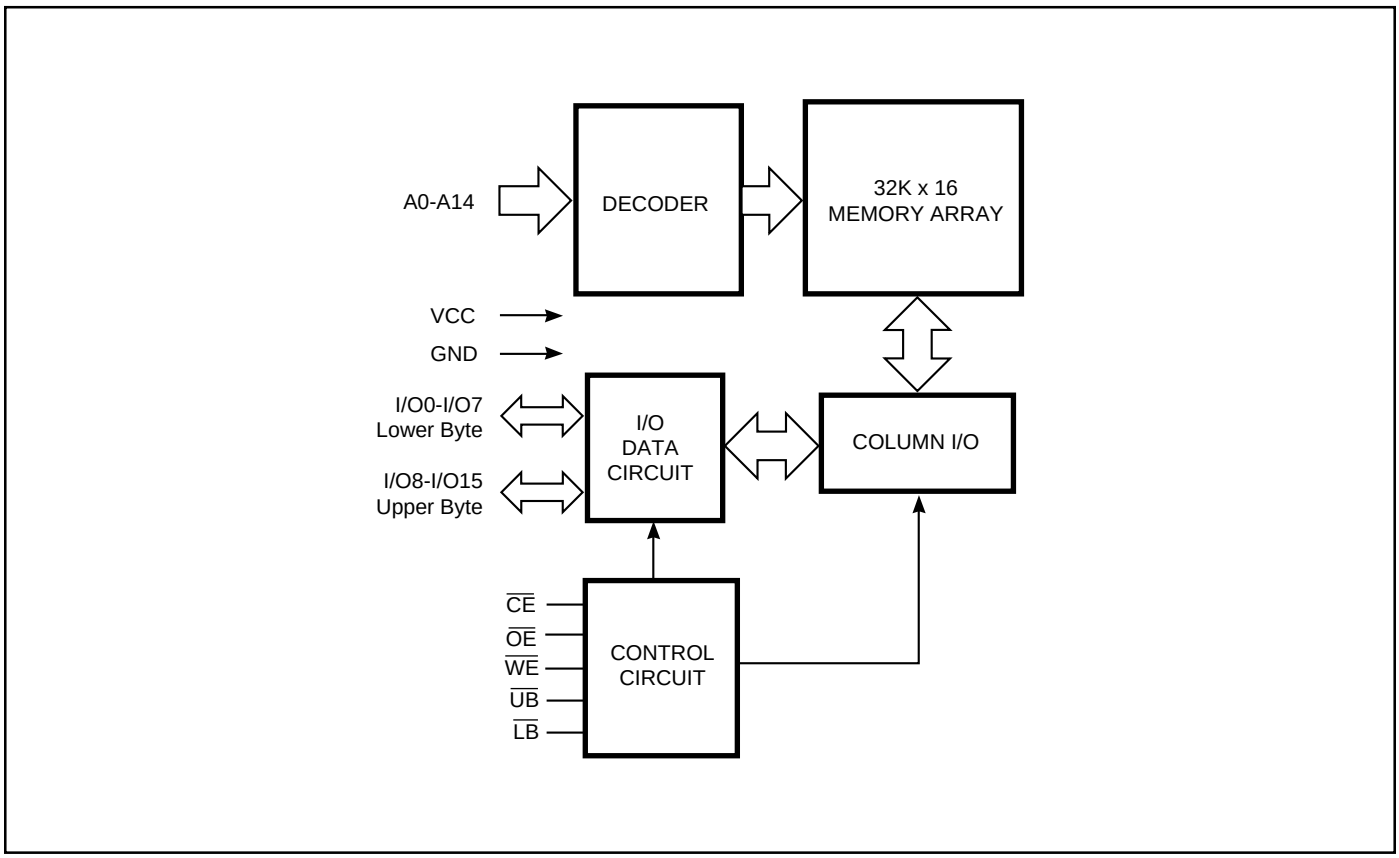
The *ICSI* IS61LV3216L is a high-speed, 512K static RAM organized as 32,768 words by 16 bits. It is fabricated using *ICSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields fast access times with low power consumption.

When $\overline{CE}$ is HIGH (deselected), the device assumes a standby mode at which the power dissipation can be reduced down to 150 μW (typical) with CMOS input levels.

Easy memory expansion is provided by using Chip Enable and Output Enable inputs, $\overline{CE}$ and $\overline{OE}$. The active LOW Write Enable ($\overline{WE}$) controls both writing and reading of the memory. A data byte allows Upper Byte ($\overline{UB}$) and Lower Byte ($\overline{LB}$) access.

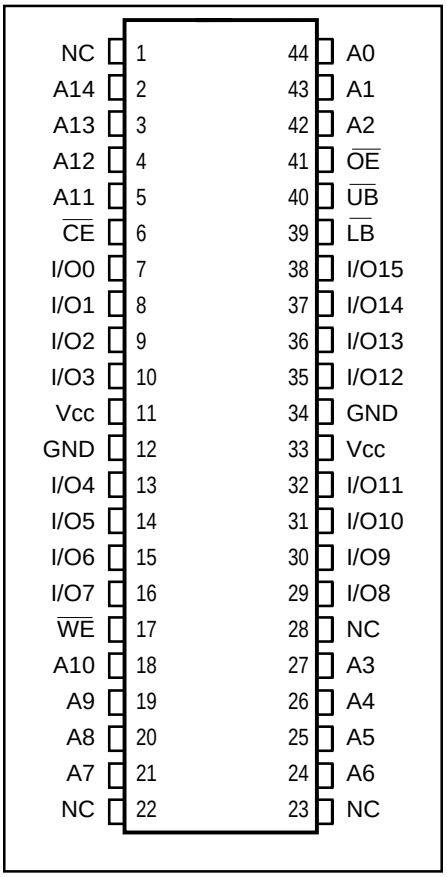
The IS61LV3216L is packaged in the JEDEC standard 44-pin 400mil SOJ and 44-pin 400mil TSOP-2.

FUNCTIONAL BLOCK DIAGRAM

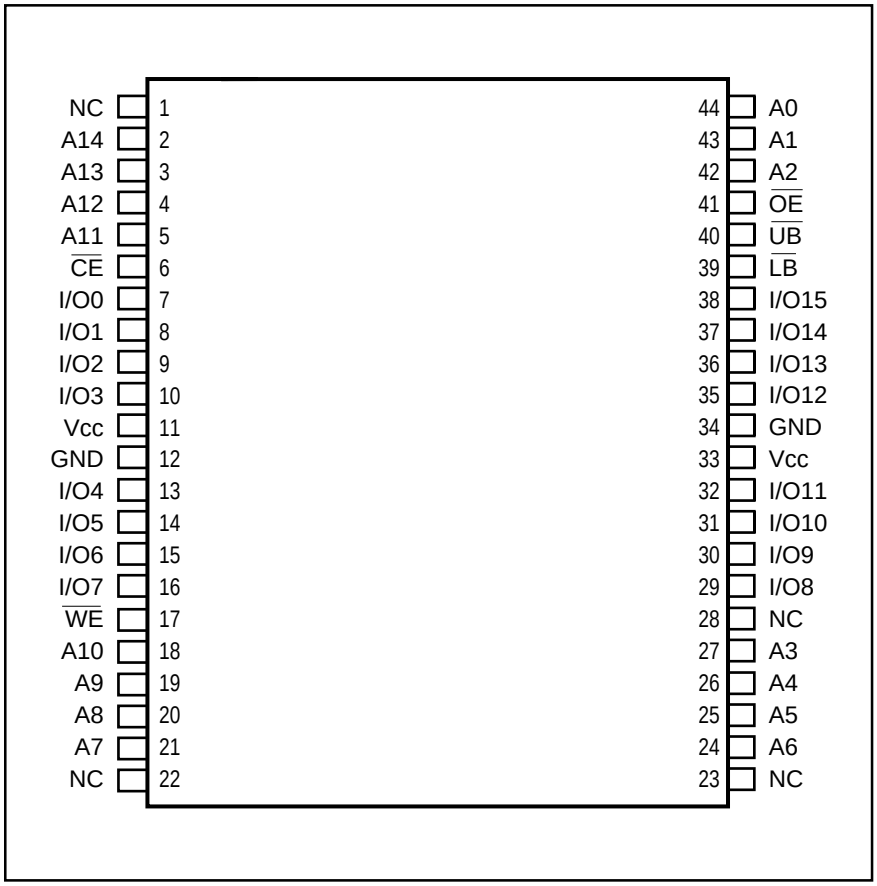


PIN CONFIGURATIONS

44-Pin SOJ



44-Pin TSOP-2



PIN DESCRIPTIONS

A0-A14	Address Inputs
I/O0-I/O15	Data Inputs/Outputs
CE	Chip Enable Input
OE	Output Enable Input
WE	Write Enable Input

LB	Lower-byte Control (I/O0-I/O7)
UB	Upper-byte Control (I/O8-I/O15)
NC	No Connection
Vcc	Power
GND	Ground

TRUTH TABLE

						I/O PIN		
Mode	**WE**	**CE**	**OE**	**LB**	**UB**	**I/O0-I/O7**	**I/O8-I/O15**	**Vcc Current**
Not Selected	X	H	X	X	X	High-Z	High-Z	I_{SB1}, I_{SB2}
Output Disabled	H	L	H	X	X	High-Z	High-Z	I_{CC}
	X	L	X	H	H	High-Z	High-Z	
Read	H	L	L	L	H	D_{OUT}	High-Z	I_{CC}
	H	L	L	H	L	High-Z	D_{OUT}	
	H	L	L	L	L	D_{OUT}	D_{OUT}	
Write	L	L	X	L	H	D_{IN}	High-Z	I_{CC}
	L	L	X	H	L	High-Z	D_{IN}	
	L	L	X	L	L	D_{IN}	D_{IN}	

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage with Respect to GND	–0.5 to +4.6	V
V_{TERM}	Terminal Voltage with Respect to GND	–0.5 to Vcc + 0.5	V
T_{STG}	Storage Temperature	–65 to +150	°C
P_T	Power Dissipation	1.0	W
I_{OUT}	DC Output Current (LOW)	20	mA

Note:
1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

Range	Ambient Temperature	Vcc 10 ns, 12 ns	Vcc 15 ns, 20 ns
Commercial	0°C to + 70°C	3.3V +10%, –5%	3.3V ± 10%
Industrial	–40°C to + 85°C	3.3V +10%, –5%	3.3V ± 10%

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = –4.0 mA	2.4	—	V
V_{OL}	Output LOW Voltage	V_{CC} = Min., I_{OL} = 8.0 mA	—	0.4	V
V_{IH}	Input HIGH Voltage		2	V_{CC} + 0.3	V
V_{IL}	Input LOW Voltage(1)		–0.3	0.8	V
I_{LI}	Input Leakage	GND ≤ V_{IN} ≤ V_{CC}	–1	1	µA
I_{LO}	Output Leakage	GND ≤ V_{OUT} ≤ V_{CC}, Outputs Disabled	–2	2	µA

Note:
1. V_{IL} (min.) = –3.0V for pulse width less than 10 ns.

POWER SUPPLY CHARACTERISTICS(1) (Over Operating Range)

				-10 ns		-12 ns		-15 ns		-20 ns		
Symbol	Parameter	Test Conditions		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
I_{CC}	Vcc Dynamic Operating Supply Current	V_{CC} = Max., I_{OUT} = 0 mA, f = f_{MAX}	Com.	—	130	—	120	—	110	—	100	mA
			Ind.	—	—	—	130	—	120	—	110	
I_{SB1}	TTL Standby Current (TTL Inputs)	V_{CC} = Max., V_{IN} = V_{IH} or V_{IL}, $\overline{CE}$ ≥ V_{IH}, f = 0	Com.	—	10	—	10	—	10	—	10	mA
			Ind.	—	—	—	10	—	10	—	10	
I_{SB2}	CMOS Standby Current (CMOS Inputs)	V_{CC} = Max., $\overline{CE}$ ≥ V_{CC} – 0.2V, V_{IN} ≥ V_{CC} – 0.2V, or V_{IN} ≤ 0.2V, f = 0	Com.	—	1	—	1	—	1	—	1	mA
			Ind.	—	—	—	1	—	1	—	1	

Note:
1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

CAPACITANCE[1]

Symbol	Parameter	Conditions	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	6	pF
C_{OUT}	Input/Output Capacitance	V_{OUT} = 0V	8	pF

Note:
1. Tested initially and after any design or process changes that may affect these parameters.

READ CYCLE SWITCHING CHARACTERISTICS[1] (Over Operating Range)

		-10		-12		-15		-20		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t_{RC}	Read Cycle Time	10	—	12	—	15	—	20	—	ns
t_{AA}	Address Access Time	—	10	—	12	—	15	—	20	ns
t_{OHA}	Output Hold Time	3	—	3	—	3	—	3	—	ns
t_{ACE}	$\overline{CE}$ Access Time	—	10	—	12	—	15	—	20	ns
t_{DOE}	$\overline{OE}$ Access Time	—	5	—	6	—	7	—	8	ns
t_{HZOE}[2]	$\overline{OE}$ to High-Z Output	0	5	0	6	0	7	0	8	ns
t_{LZOE}[2]	$\overline{OE}$ to Low-Z Output	0	—	0	—	0	—	0	—	ns
t_{HZCE}[2	$\overline{CE}$ to High-Z Output	0	5	0	6	0	7	0	8	ns
t_{LZCE}[2]	$\overline{CE}$ to Low-Z Output	3	—	3	—	3	—	3	—	ns
t_{BA}	$\overline{LB}$, $\overline{UB}$ Access Time	—	5	—	6	—	7	—	8	ns
t_{HZB}	$\overline{LB}$, $\overline{UB}$ to High-Z Output	0	5	0	6	0	7	0	8	ns
t_{LZB}	$\overline{LB}$, $\overline{UB}$ to Low-Z Output	5	—	5	—	5	—	5	—	ns

Notes:
1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. Not 100% tested.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	3 ns
Input and Output Timing and Reference Level	1.5V
Output Load	See Figures 1a and 1b

AC TEST LOADS

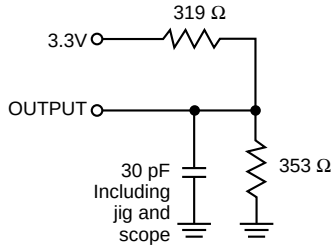


Figure 1a.

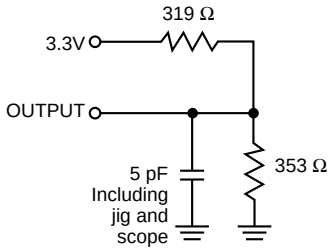
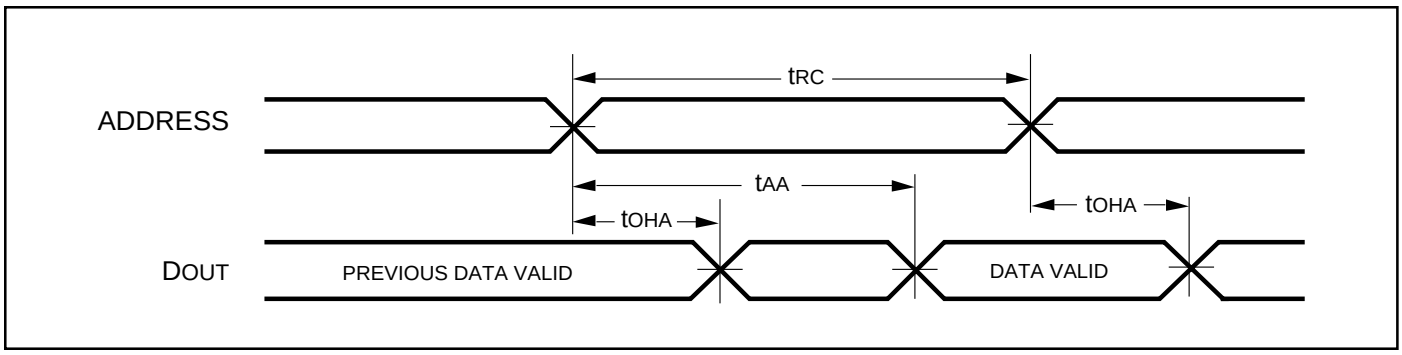


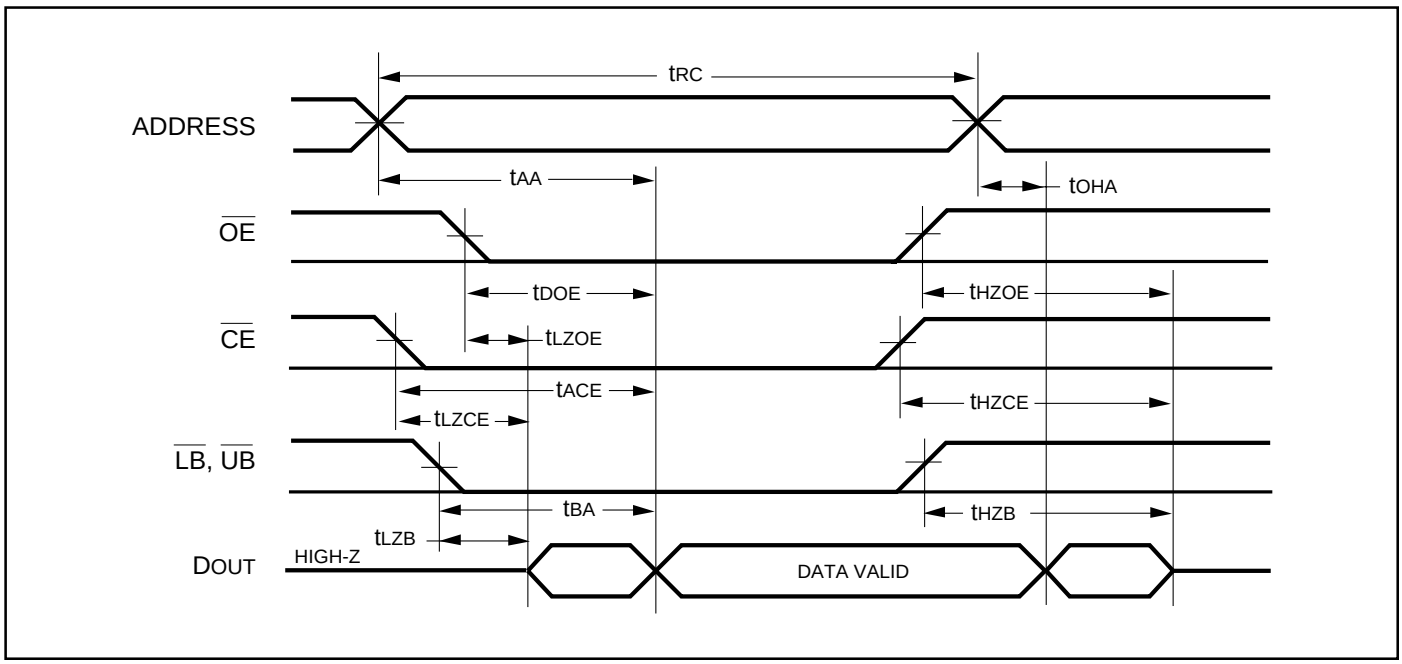
Figure 1b.

AC WAVEFORMS

READ CYCLE NO. 1[1,2] (Address Controlled) ($\overline{CE}$ = $\overline{OE}$ = V_{IL}, $\overline{UB}$ or $\overline{LB}$ = V_{IL})



READ CYCLE NO. 2[1,3]



Notes:
1. $\overline{WE}$ is HIGH for a Read Cycle.
2. The device is continuously selected. $\overline{OE}$, $\overline{CE}$, $\overline{UB}$, or $\overline{LB}$ = V_{IL}.
3. Address is valid prior to or coincident with $\overline{CE}$ LOW transition.

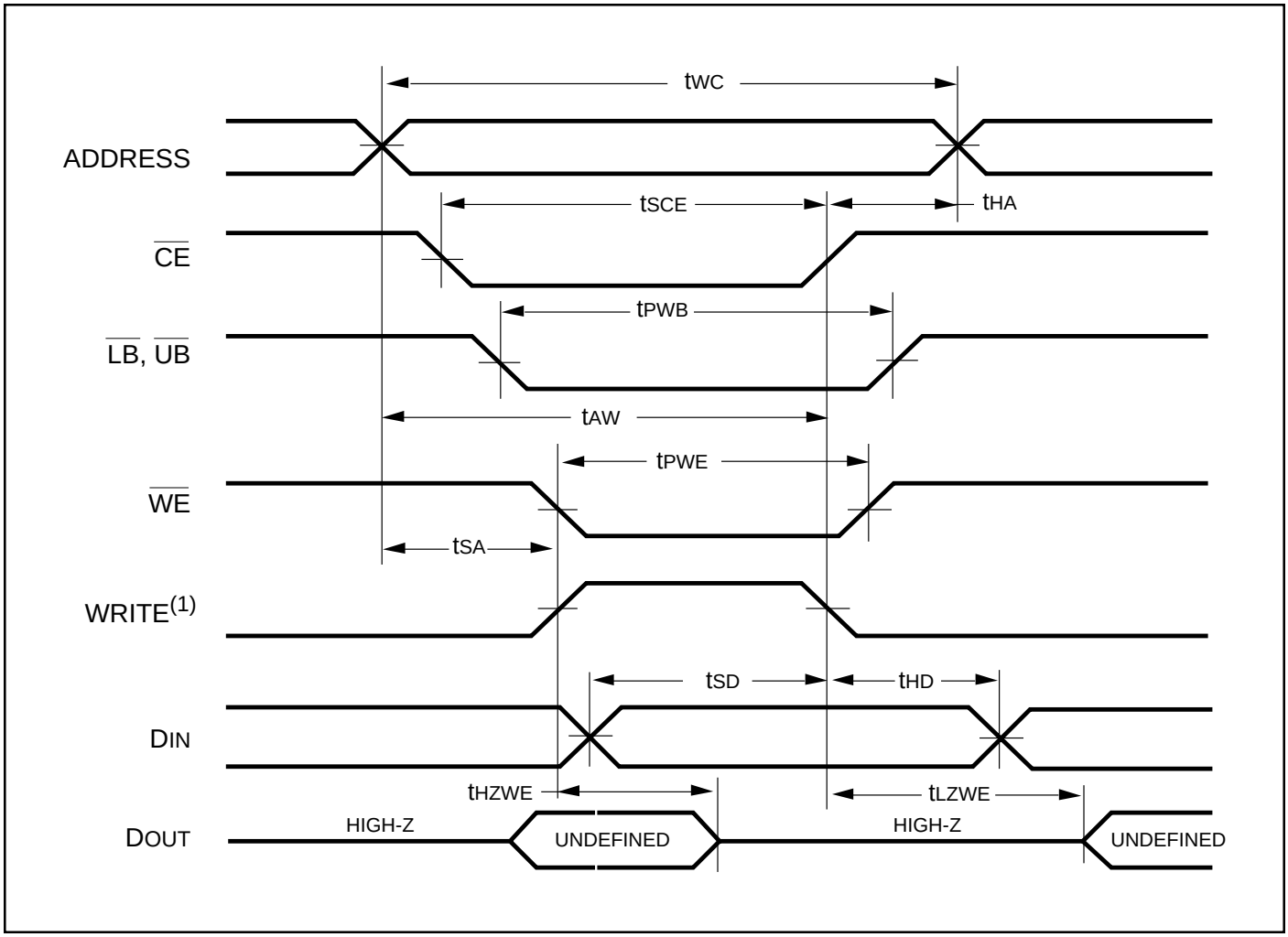
WRITE CYCLE SWITCHING CHARACTERISTICS[1,3] (Over Operating Range)

Symbol	Parameter	-10 Min.	-10 Max.	-12 Min.	-12 Max.	-15 Min.	-15 Max.	-20 Min.	-20 Max.	Unit
t_{WC}	Write Cycle Time	10	—	12	—	15	—	20	—	ns
t_{SCE}	$\overline{CE}$ to Write End	8	—	9	—	10	—	12	—	ns
t_{AW}	Address Setup Time to Write End	9	—	8	—	10	—	12	—	ns
t_{HA}	Address Hold from Write End	1	—	1	—	1	—	1	—	ns
t_{SA}	Address Setup Time	0	—	0	—	0	—	0	—	ns
t_{PWB}	$\overline{LB}$, $\overline{UB}$ Valid to End of Write	9	—	10	—	11	—	12	—	ns
t_{PWE}	$\overline{WE}$ Pulse Width	7	—	8	—	10	—	11	—	ns
t_{SD}	Data Setup to Write End	5	—	6	—	7	—	—	8	ns
t_{HD}	Data Hold from Write End	0	—	0	—	0	—	0	—	ns
t_{HZWE}[2]	$\overline{WE}$ LOW to High-Z Output	—	5	—	6	—	7	—	8	ns
t_{LZWE}[2]	$\overline{WE}$ HIGH to Low-Z Output	1	—	1	—	1	—	1	—	ns

Notes:
1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CE}$ LOW and $\overline{UB}$ or $\overline{LB}$, and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.

AC WAVEFORMS

WRITE CYCLE NO. 1 ($\overline{WE}$ Controlled)[1,2]



Notes:
1. WRITE is an internally generated signal asserted during an overlap of the LOW states on the $\overline{CE}$ and $\overline{WE}$ inputs and at least one of the $\overline{LB}$ and $\overline{UB}$ inputs being in the LOW state.
2. WRITE = ($\overline{CE}$) [($\overline{LB}$) = ($\overline{UB}$)] ($\overline{WE}$).

ORDERING INFORMATION
Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
10	IS61LV3216L-10T	400mil TSOP-2
	IS61LV3216L-10K	400mil SOJ
12	IS61LV3216L-12T	400mil TSOP-2
	IS61LV3216L-12K	400mil SOJ
15	IS61LV3216L-15T	400mil TSOP-2
	IS61LV3216L-15K	400mil SOJ
20	IS61LV3216L-20T	400mil TSOP-2
	IS61LV3216L-20K	400mil SOJ

ORDERING INFORMATION
Industrial Range: –40°C to +85°C

Speed (ns)	Order Part No.	Package
12	IS61LV3216L-12TI	400mil TSOP-2
	IS61LV3216L-12KI	400mil SOJ
15	IS61LV3216L-15TI	400mil TSOP-2
	IS61LV3216L-15KI	400mil SOJ
20	IS61LV3216L-20TI	400mil TSOP-2
	IS61LV3216L-20KI	400mil SOJ

Integrated Circuit Solution Inc.
HEADQUARTER:
NO.2, TECHNOLOGY RD. V, SCIENCE-BASED INDUSTRIAL PARK,
HSIN-CHU, TAIWAN, R.O.C.
TEL: 886-3-5780333
Fax: 886-3-5783000

BRANCH OFFICE:
7F, NO. 106, SEC. 1, HSIN-TAI 5TH ROAD,
HSICHIH TAIPEI COUNTY, TAIWAN, R.O.C.
TEL: 886-2-26962140
FAX: 886-2-26962252
http://www.icsi.com.tw